

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Kohtaro Osakada	04/07/2008
Daisuke Takeuchi	04/07/2008
Sehoon Park	04/07/2008
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11958905
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PATENT
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**ASSIGNMENT
(PATENT APPLICATION)**

WHEREAS, we, ("ASSIGNORS"):

<u>Inventor</u>	<u>Citizenship</u>	<u>Address</u>
Kohtaro OSAKADA	Japanese	c/o Tokyo Institute of Technology, 4259, Nagatsuta-chi, Midori-ku, Yokohama-shi, Kanagawa, Japan
Daisuke TAKEUCHI	Japanese	c/o Tokyo Institute of Technology, 4259, Nagatsuta-chi, Midori-ku, Yokohama-shi, Kanagawa, Japan
Sehoon PARK	Korean	c/o Tokyo Institute of Technology, 4259, Nagatsuta-chi, Midori-ku, Yokohama-shi, Kanagawa, Japan

having invented a certain new and useful invention entitled:

DIENE POLYMER AND PROCESS FOR PRODUCING THE SAME

for which a United States patent application is to be filed or has been filed on December 18, 2007 under U.S. Patent Application No. 11/958,905; and

WHEREAS, ("ASSIGNEES"):

Tokyo Institute of Technology
(a Japanese University)
12-1, Ookayama 2-chome,
Meguro-ku, Tokyo 152-8550,
Japan

are desirous of acquiring the entire right, title and interest in and to the invention throughout the United States or the world, and all right, title and interest in, to and under any and all Letters Patent of the United States or all countries throughout the world;

FOR GOOD and VALUABLE CONSIDERATION, the full receipt and sufficiency of which are hereby acknowledged, ASSIGNORS, intending to be legally bound, do hereby:

AUTHORIZE said ASSIGNEES, or their representatives to insert above the filing date and application number of the application when these are known;

SELL, ASSIGN, TRANSFER and CONVEY to ASSIGNEES the whole and entire right, title and interest for the United States and its possessions and territories and all foreign countries in and to

the invention which is disclosed in the above-identified patent application, and, in and to any and all patent applications related thereto including, but not limited to, all provisionals, non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues and all other applications for patent which have been or shall be filed in the United States and all foreign countries on the invention; all original, reissued and reexamined patents and extensions thereof which have been or shall be issued in the United States and all foreign countries on the invention to the full end of the term or terms for which the patent(s) may be granted, as fully and entirely as the same would have been held by the undersigned ASSIGNORS had this Assignment not been made; and specifically including all rights of priority created by the above patent application under any treaty, convention or law relating thereto;

AUTHORIZE and REQUEST the issuing authority to issue any and all United States and foreign patents granted on the invention to ASSIGNEES;

WARRANT and REPRESENT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by ASSIGNORS, and that the full right to convey the same as herein expressed is possessed by ASSIGNORS;

AGREE and UNDERTAKE, when requested and at the expense of ASSIGNEES, to carry out in good faith the intent and purpose of this Assignment, ASSIGNORS will execute all non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues, and all other patent applications on the invention; execute all lawful oaths, declarations, assignments, powers of attorney and other papers; communicate to ASSIGNEES all facts known to ASSIGNORS relating to the invention and the history thereof; and generally do everything possible which ASSIGNEES shall consider desirable for vesting title to the invention in ASSIGNEES, and for securing, maintaining and enforcing proper patent protection for the invention; all without further compensation to ASSIGNORS;

AGREES to hold in trust, keep confidential, not make use of, and not disclose or reveal to any third party said invention, without ASSIGNEES' prior written consent.

TO BE BINDING on the heirs, assigns, representatives and successors of ASSIGNORS and extending to the successors, assigns, and nominees of ASSIGNEES.

April 7, 2008

Date

April 7, 2008

Date

April 7, 2008

Date

Kohtaro Oskada

Kohtaro OSAKADA

Daisuke Takeuchi

Daisuke TAKEUCHI

[Signature]

Schoon PARK